PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Yueh-Ying Tsai	05/31/2010
Fu-Di Tang	05/31/2010
Chien-Ping Huang	05/31/2010
Chun-Chi Ke	05/31/2010

RECEIVING PARTY DATA

Name:	Siliconware Precision Industries Co., Ltd.	
Street Address:	No. 123, Sec. 3, Da Fong Road, Tantzu	
City:	Taichung	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12967839

CORRESPONDENCE DATA

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NAME OF SUBMITTER:	Peter F. Corless

Total Attachments: 1

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PATENT REEL: 025499 FRAME: 0645 DD-075(26690US)

ASSIGNMENT OF U.S. PATENT APPLICATION

In consideration of the sum of One Dollar in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned Inventor(s) 1. Yueh-Ying TSAI 2. Fu-Di TANG Full Name(s) 3. Chien-Ping HUANG 4. Chun-Chi KE Hereby sell, assign and transfer to SILICONWARE PRECISION INDUSTRIES CO., LTD. Assignee Name and Address No. 123, Sec. 3, Da Fong Road, Tantzu, Taichung, Taiwan, R.O.C. (hereinafter called the Assignee) the entire right, title, and interest in and to any and all improvements which are disclosed in the Application for United States Letters Patent entitled SEMICONDUCTOR PACKAGE WITHOUT CHIP CARRIER AND Title of Invention: FABRICATION METHOD THEREOF Which application was a) executed by the undersigned on Complete either b) filed on the _____ Serial No. Including any and all United States Letters Patents which may be granted therefore and any and all extensions, divisions, reissues, substitutes, renewals or continuations thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property. It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said assignee. Further, it is agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, continuing, substitute, renewal, and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining proper patent protection. Date Signed at ____TAIWAN, R.O.C. On May 31, 2010 Inventor(s) Full Signature(s) Chien-Ping HUANG Chan-chi Lee Chun-Chi KE

> PATENT REEL: 025499 FRAME: 0646

RECORDED: 12/14/2010